



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In the application of )  
)  
Chad Boyd, et al. )  
)  
Serial No. 10/696,223 )  
)  
Filed: October 29, 2003 )  
)  
For: SINGLE INGREDIENT, )  
MULTI-STRUCTURAL FILAMENTS )

CERTIFICATE OF MAILING

I hereby certify that this correspondence was deposited with the United States Postal Service as first class mail in an envelope addressed to: Mail Stop Missing Parts, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450 on 5<sup>th</sup> day of October, 2004.

  
Melinda A. Miller, sec'y to Rodney L. Skoglund

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

PRELIMINARY AMENDMENT

Sir:

In response to the Notice of Omitted Items in a Nonprovisional Application mailed September 27, 2004, the Applicants reply as follows:

Amendments to the Specification begin on page 2 of this paper.

Remarks/Arguments begin on page 3 of this paper.

An Appendix including a marked up copy of the renumbered pages of the specification, including the claims and abstract pages, and a clean copy of a substitute specification is attached following page 3 of this paper.